

DHG30IM600PC

preliminary

 $V_{RRM} = 600 V$

 $I_{FAV} = 30 A$

 $t_{rr} = 40 \, \text{ns}$

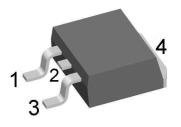
High Performance Fast Recovery Diode Low Loss and Soft Recovery Single Diode

Sonic Fast Recovery Diode

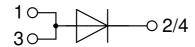
Part number

DHG30IM600PC

Marking on Product: DHG30IM600PC



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-263 (D2Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

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Fast Diode				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blockii	$T_{VJ} = 25^{\circ}C$			600	V	
V _{RRM}	max. repetitive reverse blocking vo	$T_{VJ} = 25^{\circ}C$			600	٧	
IR	reverse current, drain current	$V_R = 600 \text{ V}$	$T_{VJ} = 25^{\circ}C$			50	μΑ
		$V_R = 600 \text{ V}$	$T_{VJ} = 125^{\circ}C$			4	mΑ
V _F	forward voltage drop	I _F = 30 A	$T_{VJ} = 25^{\circ}C$			2.27	V
		$I_F = 60 \text{ A}$				3.14	٧
		I _F = 30 A	T _{vJ} = 125°C			2.24	٧
		$I_F = 60 \text{ A}$				3.23	٧
I _{FAV}	average forward current	T _c = 95°C	T _{VJ} = 150°C			30	Α
		rectangular $d = 0.5$					i ! !
V _{F0}	threshold voltage		T _{vJ} = 150°C			1.17	V
r _F	slope resistance	ss calculation only				32	mΩ
R _{thJC}	thermal resistance junction to case	9				0.7	K/W
R _{thCH}	thermal resistance case to heatsin	k			0.25		K/W
P _{tot}	total power dissipation		$T_{C} = 25^{\circ}C$			180	W
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			200	Α
CJ	junction capacitance	$V_R = 400 \text{V}$ f = 1 MHz	$T_{VJ} = 25^{\circ}C$		16		pF
I _{RM}	max. reverse recovery current		T _{VJ} = 25 °C		13		Α
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}$	$T_{VJ} = 125$ °C		17		Α
t _{rr}	reverse recovery time	$\begin{cases} I_F = 30 \text{ A; } V_R = 400 \text{ V} \\ -\text{di}_F/\text{dt} = 600 \text{ A}/\mu\text{s} \end{cases}$	$T_{VJ} = 25 ^{\circ}\text{C}$		40		ns
	J	1	$T_{VJ} = 125$ °C		60		ns

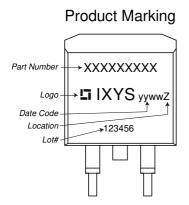


DHG30IM600PC

preliminary

Package	e TO-263 (D2Pak))-263 (D2Pak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit		
RMS	RMS current	per terminal 1)			35	Α		
T _{vJ}	virtual junction temperature		-55		150	°C		
T _{op}	operation temperature		-55		125	°C		
T _{stg}	storage temperature		-55		150	°C		
Weight				1.5		g		
F _c	mounting force with clip		20		60	Ν		

¹⁾ l_{nusc} is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a product with multiple pins for one chip-potential, the current capability can be increased by connecting the pins as one contact.



Part description

D = Diode

H = Sonic Fast Recovery Diode

G = extreme fast

30 = Current Rating [A]

IM = Single Diode

600 = Reverse Voltage [V]

PC = TO-263AB (D2Pak) (2)

Ordering	Ordering Number	Ordering Number Marking on Product		Quantity	Code No.
Standard	DHG30IM600PC-TRL	DHG30IM600PC	Tape & Reel	800	503501
Alternative	DHG30IM600PC-TUB	DHG30IM600PC	Tube	50	525078

Similar Part	Package	Voltage class
DHG30I600PA	TO-220AC (2)	600
DHG30I600HA	TO-247AD (2)	600

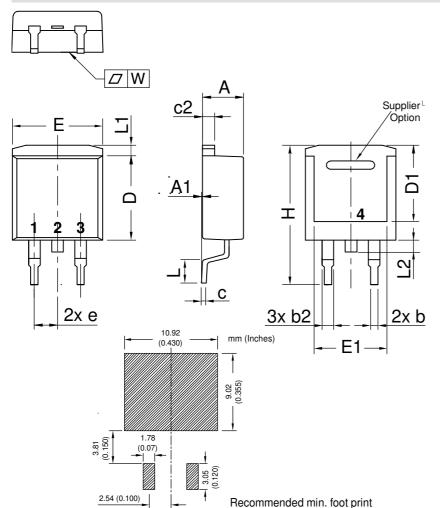
Equivalent Circuits for Simulation			* on die level	$T_{VJ} = 150$ °C
$I \rightarrow V_0$)—[R ₀]–	Fast Diode		
V _{0 max}	threshold voltage	1.17		V
$R_{0 \text{ max}}$	slope resistance *	29		$m\Omega$





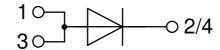
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Outlines TO-263 (D2Pak)



Dim.	Millir	neter	Inches		
DIIII.	min	max	min	max	
Α	4.06	4.83	0.160	0.190	
A1	typ.	0.10	typ. 0.004		
A2	2.	41	0.095		
b	0.51	0.99	0.020	0.039	
b2	1.14	1.40	0.045	0.055	
С	0.40	0.74	0.016	0.029	
c2	1.14	1.40	0.045	0.055	
D	8.38	9.40	0.330	0.370	
D1	8.00	8.89	0.315	0.350	
D2	2	.5	0.098		
Е	9.65	10.41	0.380	0.410	
E1	6.22	8.50	0.245	0.335	
е	2,54	4 BSC 0,100 BSC		BSC	
e1	4.28		0.1	69	
Н	14.61	15.88	0.575	0.625	
L	1.78 2.79		0.070	0.110	
L1	1.02 1.68		0.040	0.066	
W	typ. 0.02	0.040	typ. 0.0008	0.002	

All dimensions conform with and/or within JEDEC standard.





Fast Diode

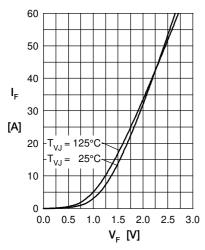


Fig. 1 Typ. Forward current versus V_F

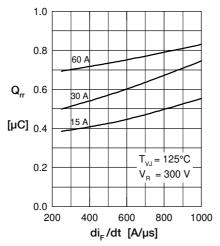


Fig. 2 Typ. reverse recov. charge Q_{rr} versus di/dt

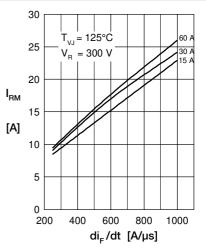


Fig. 3 Typ. peak reverse current $I_{\rm RM}$ versus di/dt

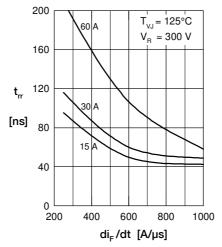
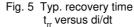
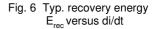


Fig. 4 Dynamic parameters Q_{rr} , I_{RM} versus T_{VJ}





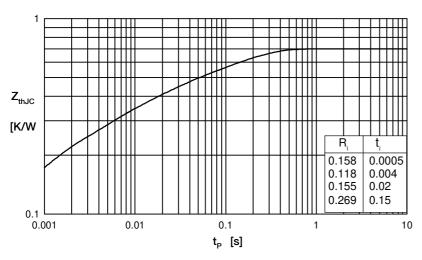


Fig. 7 Typ. transient thermal impedance junction to case

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25.163.2453.0 25.3	163.4253.0	25.190.2053.0	25.194.3453.0	25.320.4853.1	25.320.5253.1	25.326.3253.1	25.326.3553.1	25.330.1653.1
25.330.4753.1 25.3	330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>	<u>T485F</u> <u>T485H</u>
T512F-YEB T513	F T514F T	554 <u>T612FSE</u>	25.161.3453.0	25.179.2253.0	25.194.3253.0	25.325.1253.1	25.326.4253.1	25.330.0953.1
25.332.4353.1 25.3	350.1653.0	25.350.2453.0	25.352.1453.0	25.352.1653.0	25.352.2453.0	25.352.5453.1	25.522.3353.0	25.602.4053.0
25.640.5053.0								